

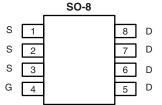
**Vishay Siliconix** 

### N-Channel 30-V (D-S) MOSFET with Schottky Diode

MOSFET PRODUCT SUMMARY						
V <sub>DS</sub> (V)	I <sub>D</sub> (A)					
30	0.016 at V <sub>GS</sub> = 10 V	9.5				
	0.021 at V <sub>GS</sub> = 4.5 V	7.7				

#### SCHOTTKY PRODUCT SUMMARY

V <sub>DS</sub> (V)	V <sub>SD</sub> (V) Diode Forward Voltage	I <sub>F</sub> (A)
30	0.50 V at 1.0 A	1.4



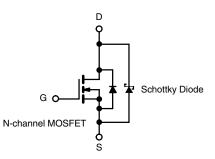
Top View

Ordering Information: Si4812BDY-T1-E3 (Lead (Pb)-free) Si4812BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Available
- LITTLE FOOT<sup>®</sup> Plus Power MOSFET
- 100 % Rg Tested





ABSOLUTE MAXIMUM RATINGS	T <sub>A</sub> = 25 °C, unle	ss otherwise	noted		
			Limit		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage (MOSFET)		V <sub>DS</sub>	30		V
Reverse Voltage (Schottky)		V DS	30		
Gate-Source Voltage (MOSFET)		V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>J</sub> = 150 °C) (MOSFE <sup>-</sup>	T) <sup>a, b</sup> T <sub>A</sub> = 25 °C	la la	9.5	7.3	
Continuous Drain Current $(T_j = 130^{\circ}C)$ (MOSFE	$T_A = 70 ^{\circ}C$	I <sub>D</sub>	7.7	5.9	
Pulsed Drain Current (MOSFET)	I <sub>DM</sub>	50			
Continuous Source Current (MOSFET Diode Cond	ا <sub>S</sub>	2.1	1.2	A	
Average Forward Current (Schottky)	١ <sub>F</sub>	1.4	0.8		
Pulsed Forward Current (Schottky)	I <sub>FM</sub>	30			
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	5 1.25		
Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>			mJ
Maximum Power Dissipation (MOSFET) <sup>a, b</sup>	T <sub>A</sub> = 25 °C		2.5	1.4	w
Maximum Power Dissipation (MOSFET) <sup>2, 2</sup>	T <sub>A</sub> = 70 °C	PD	1.6	0.9	
Maximum Dawar Dissinction (Schottlay)a, b	T <sub>A</sub> = 25 °C	'U	2.0	1.2	
Maximum Power Dissipation (Schottky) <sup>a, b</sup>	T <sub>A</sub> = 70 °C		1.3	0.8	
Operating Junction and Storage Temperature Ran	T <sub>J</sub> , T <sub>stg</sub>	- 55	i to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Device	Symbol	Typical	Maximum	Unit	
	MOSFET		40	50	- °C/W	
Maximum Junction-to-Ambient (t $\leq$ 10 s) <sup>a</sup>	Schottky	<b>B</b>	50	60		
	MOSFET	R <sub>thJA</sub>	72	90		
Maximum Junction-to-Ambient (t = Steady State) <sup>a</sup>	Schottky		85	100		
	MOSFET	P	18	23		
Maximum Junction-to-Foot (t = Steady State) <sup>a</sup>	Schottky	R <sub>thJF</sub> –	24	30		

Notes:

a. Surface Mounted on FR4 board.

b.  $t \le 10$  s.

### Si4812BDY

#### Vishay Siliconix

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Cymbol			.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	maxi	•	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		0.004	0.100		
Zero Gate Voltage Drain Current (MOSFET and Schottky)	I <sub>DSS</sub>	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 100 °C		0.7	10	mA	
		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C		3.0	20		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20			А	
	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$		0.013	0.016		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7.7 \text{ A}$		0.0165	0.021	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$		45		S	
	V	I <sub>S</sub> = 1.0 A, V <sub>GS</sub> = 0 V	V 0.45		0.50		
Schottky Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{S}$ = 1.0 A, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C		0.33	0.42	V	
Dynamic <sup>b</sup>	· · ·		•	•			
Total Gate Charge	Qg			8.5	13		
Gate-Source Charge	Q <sub>gs</sub>	$Q_{gs}$ V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 9.5 A		3		nC	
Gate-Drain Charge	Q <sub>gd</sub>			2.6			
Gate Resistance	Rg		0.3	0.7	1.1	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	25		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		13	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 1 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 6 $\Omega$		20	30	ns	
Fall Time	t <sub>f</sub>			8	15		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 1.0 A, dl/dt = 100 A/μs		22	35		

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





# **Si4812BDY**

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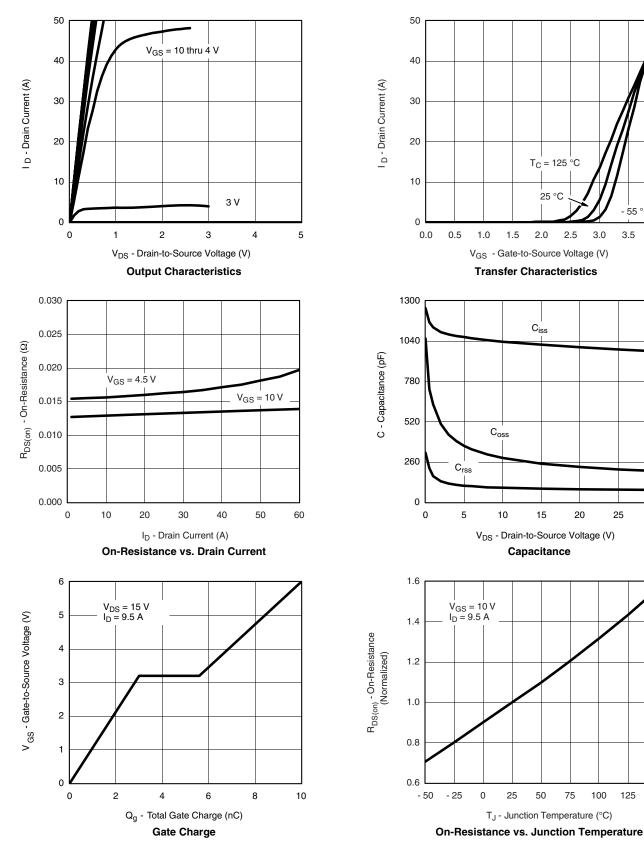
- 55 °C

4.0

30

3.5

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

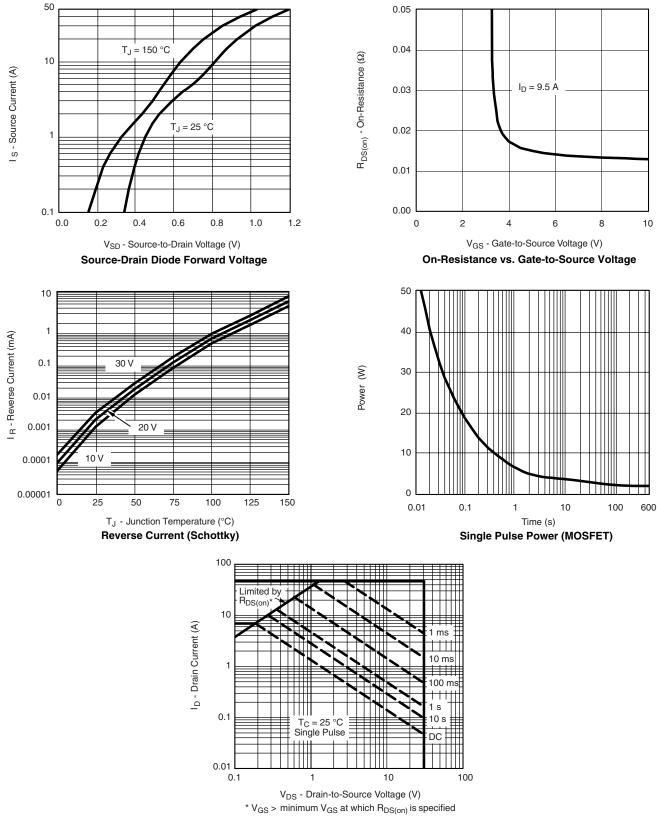


150

#### Si4812BDY

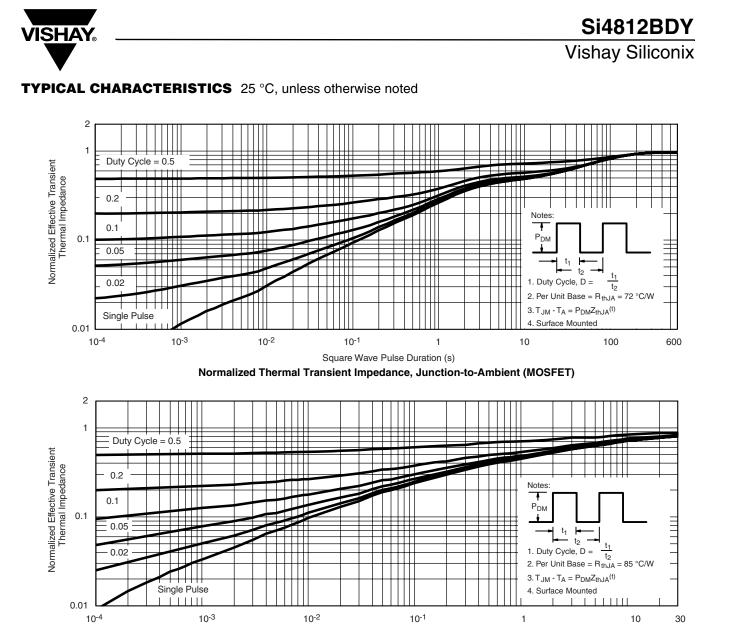
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Safe Operating Area, Junction-to-Case

VISHA



Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient (Schottky)

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73038">www.vishay.com/ppg?73038</a>.



# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

### **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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